IPC ASSOCIATION CO ELECTRONICS IN	© Copyright 2005. IF	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.		inder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi				terials and M	fg Information	on		
upplier Iı	nformation													
Company name*			Company un	ompany unique ID			Unique ID Authority			Respon	Response Date*			
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roduct-Env	v-Stewards		Product Enviro Compliance			1	NA			Produc	Product-Env-Stewards@onsemi.com			
uthorized R	Representative*	Title - Representative			P	Phone - Representative*			Email -	Email - Representative*				
Product-Env-Stewards Prod			Product Envi	Product Enviro Compliance			NA			Produc	Product-Env-Stewards@onsemi.com			
R	Requester Item Number	Mfr Item	Mfr Item Number M		Mfr Item Name		Effective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type	
		NXH35C G	C120L2C2ES	TMPIM 1200V 3.	5A enhance CII	3	2025-05-11		VN2		78076.51	mg	Each	
lanufactu	uring Proccess Informat	tion												
Те	Terminal Plating / Grid Array Material Te			erminal Base Alloy J-STD-020 MSI		L Rating	Peak Process Body Temperature Max Time at Peak			eak Tempera	Temperature Number of Reflow Cycles			
Matte Tin (Sn) - annealed		C	CU Alloy NA		NA		0	С	30	secor	ids 3			
					-		•							

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybrominated Biphenyls (Pl	aterial for Cadmium and quantity limit of 0.1% by BB), Polybrominated Diphenyl Ethers (PBDE), an								
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms andConditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	cceptance *	Accepted						
Exemption: If the declared item does not applicable exemptions.	contain RoHS restricted substances per	the definition above except for defined Ro	oHS exemptions, then select the corresponding	response in the R	oHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
DBC	17028.0	mg	Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		7151.7598	mg
			Supplier	Copper (Cu)	7440-50-8		9876.2393	mg
Die	223.81	mg	Supplier	Silicon (Si)	7440-21-3		223.81	mg
Die Attach Solder	750.0	mg	Supplier	Silver (Ag)	7440-22-4		18.75	mg
			Supplier	Tin (Sn)	7440-31-5		727.5	mg
			Supplier	Copper (Cu)	7440-50-8		3.75	mg
Lead Frame	6950.0	mg	Supplier	Tin (Sn)	7440-31-5		0.695	mg
			В	Nickel (Ni)	7440-02-0		0.695	mg
			Supplier	Copper (Cu)	7440-50-8		6947.2197	mg
			Supplier	Phosphorus (P)	7723-14-0		1.39	mg
Mold Compound-Black	52800.0	mg		Metal Hydroxide	proprietary data		1320	mg
			Supplier	Carbon Black (C)	1333-86-4		264	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		44880	mg
			Supplier	EpoxyNovolaCresins (Cresolic)	64425-89-4		3696	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		2640	mg
Thermistor	38.5	mg	Supplier	Tin (Sn)	7440-31-5		0.4813	mg
			Supplier	Nickel Oxide (NiO)	1313-99-1		0.0578	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		0.0616	mg
			В	Nickel (Ni)	7440-02-0		8.9897	mg
			Supplier	Gold (Au)	7440-57-5		0.0077	mg
			Supplier	Iron (Fe)	7439-89-6		9.625	mg
			A	Lead Oxide (PbO)	1317-36-8		8.8242	mg
			Supplier	Cobalt Oxide (Co3O4)	1308-06-1		0.0578	mg
			Supplier	Manganese Tetraoxide (Mn3O4)	1317-35-7		0.0578	mg
			Supplier	Potassium Monoxide (K2O)	12136-45-7		0.7469	mg
			Supplier	Copper (Cu)	7440-50-8		4.2543	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		5.3361	mg
Wire Bond - Al	286.2	mg	Supplier	Silicon (Si)	7440-21-3		2.862	mg
			В	Nickel (Ni)	7440-02-0		14.31	mg
			Supplier	Aluminum (Al)	7429-90-5		269.028	mg